OPE		,						
TRANSMITTAL LETTER (General - Patent Pending)				Docket No. 11948.26				
In Re Application	Of: Tangpuz, et al.							
Application No. 10/678,010	Filing Date 10/2/03	Examiner Ho	Customer No. 27,966	Group Art Unit 2818	Confirmation No.			
Title: METHOD FOR MAINTAINING SOLDER THICKNESS IN FLIPCHIP ATTACH PACKAGING PROCESSES								
COMMISSIONER FOR PATENTS:								
Transmitted herew	rith is:							
Response to Rest	riction Requirement;	Petition for Extension of Time						
in the above ident	ified application.							

X N	o ac	iditional	tee is	required.
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☐ A check in the amount of

50-0843 as described below.

Charge the amount of

Credit any overpayment.

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is attached.

Signature

Kenneth E. Horton, 27,966

Kirton & McConkie P.O. Box 45120

Salt Lake City, UT 84145-0120

Dated: November 30, 2004

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on

November 30, 2004

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Signature of Person Mailing Correspondence

JoAnn Bawden

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